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Schottky Barrier Diodes

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.



- Fast Switching Speed
- Low Leakage Current
- Low Forward Voltage -0.45 V @ $I_F = 1 \text{ mAdc}$
- Surface Mount Device
- Low Capacitance Diode
- NSVR Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|--------------|-------------|
| Total Device Dissipation FR–5 Board, (Note 1) T _A = 25°C Derate above 25°C | P _D | 200 1.57 | mW mW/°C |
| Forward Current (DC) | I _F | 200 | mA |
| Non-Repetitive Peak Forward Current, t _p < 10 msec | I _{FSM} | 2 | Α |
| Thermal Resistance Junction-to-Ambient | $R_{	heta JA}$ | 635 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | -55 to150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 Minimum Pad



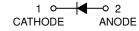
ON Semiconductor®

www.onsemi.com

100 VOLT SCHOTTKY BARRIER DIODE



SOD-323 CASE 477 STYLE 1



MARKING DIAGRAM



JC = Device Code M = Date Code • Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|----------------------|------------------------|
| NSR02100HT1G | SOD-323 (Pb-Free) | 3,000 / Tape & Reel |
| NSVR02100HT1G | SOD-323 (Pb-Free) | 3,000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------------|-----|-----|------|------|
| Reverse Breakdown Voltage $(I_R = 10 \mu A)$ | V _R | _ | 100 | _ | V |
| Reverse Leakage (V _R = 50 V) | I _R | - | - | 0.05 | μAdc |
| Reverse Leakage (V _R = 100 V) | I _R | _ | - | 0.15 | μAdc |
| Forward Voltage (I _F = 1 mAdc) | V _F | - | _ | 0.45 | Vdc |
| Forward Voltage (I _F = 10 mAdc) | V _F | _ | _ | 0.57 | Vdc |
| Forward Voltage (I _F = 100 mAdc) | V _F | _ | _ | 0.80 | Vdc |
| Forward Voltage (I _F = 200 mAdc) | V _F | - | - | 0.95 | Vdc |
| Total Capacitance $(V_R = 1.0 \text{ V}, f = 1.0 \text{ MHz})$ | C _T | _ | 4 | 10 | pF |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

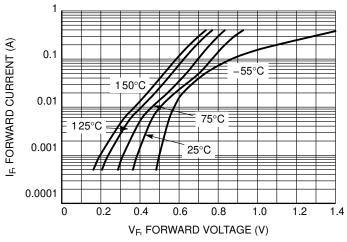


Figure 1. Forward Voltage

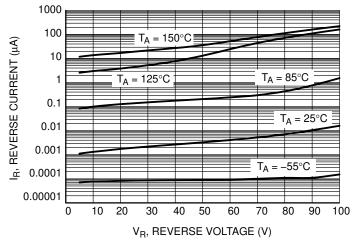


Figure 2. Leakage Current

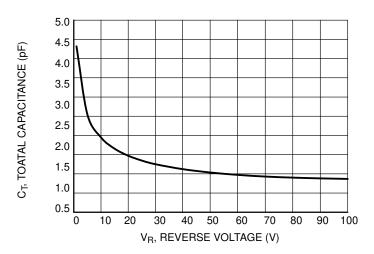
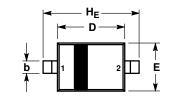
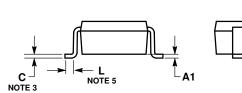


Figure 3. Total Capacitance

PACKAGE DIMENSIONS

SOD-323 CASE 477-02 **ISSUE H**





NOTES

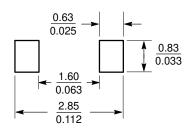
- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETERS.
- LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 5. DIMENSION L IS MEASURED FROM END OF RADIUS.

| | MILLIMETERS | | | INCHES | | | |
|-----|-------------|------|-------|-----------|-------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.80 | 0.90 | 1.00 | 0.031 | 0.035 | 0.040 | |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 | |
| A3 | 0.15 REF | | | 0.006 REF | | | |
| b | 0.25 | 0.32 | 0.4 | 0.010 | 0.012 | 0.016 | |
| С | 0.089 | 0.12 | 0.177 | 0.003 | 0.005 | 0.007 | |
| D | 1.60 | 1.70 | 1.80 | 0.062 | 0.066 | 0.070 | |
| E | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 | |
| L | 0.08 | | | 0.003 | | | |
| HE | 2.30 | 2.50 | 2.70 | 0.090 | 0.098 | 0.105 | |

STYLE 1: PIN 1. CATHODE (POLARITY BAND)

2. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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